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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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MX573ABB106M250

Ultra-Low Jitter 106.25MHz LVDS XO

ClockWorks® FUSION

General Description

The MX573ABB106M250 is an ultra-low phase jitter XO with LVDS output optimized for high line rate applications.

Applications

- Fibre Channel 10G/12G SERDES

Absolute Maximum Ratings

Supply Voltage (VIN).....	+4.6V
Lead Temperature (soldering, 10s).....	260°C
Storage Temperature (T _s).....	125°C
ESD Rating (HBM).....	2kV

Electrical Characteristics

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, outputs terminated with 100 Ohms between Q and /Q.¹

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
IDD	Supply Current				90	mA
F0	Center Frequency			106.25		MHz
	Frequency Stability	Note 2			±50	ppm
∅j	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		220 100		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		100		400	ps
	Duty Cycle		45		55	%
VOH	Output High Voltage VOH max = VCM max + 1/2 VOD max	LVDS output levels	1.248	1.375	1.602	V
VOL	Output Low Voltage VOL min = VCM min - 1/2 VOD max	LVDS output levels	0.898	1.025	1.252	V
VOD	Output Differential Voltage		247	350	454	mV
VCM	Common Mode Output Voltage		1.125	1.2	1.375	V

Notes:

1. Guaranteed after thermal equilibrium.
2. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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Microchip Technology Inc.

<http://www.microchip.com>

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Revision 1.0
tcghelp@microchip.com

Features

- 106.25MHz LVDS
- Typical phase noise:
 - 100fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 7mm x 5mm LGA package

Operating Ratings

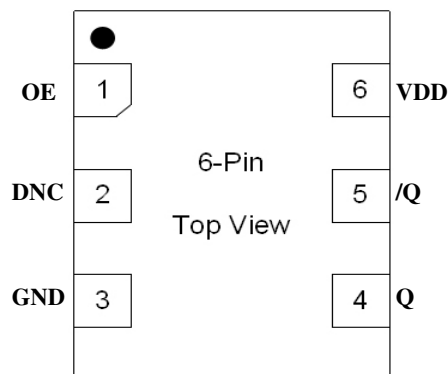
Supply Voltage (VIN).....	+2.375V to +3.63V
Ambient Temperature (TA).....	-40°C to +85°C

Ordering Information

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX573ABB106M250	MX573AB	B106M250	Tube	6-Pin 7mm x 5mm LGA
MX573ABB106M250-TR	MX573AB	B106M250	Tape and Reel	6-Pin 7mm x 5mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

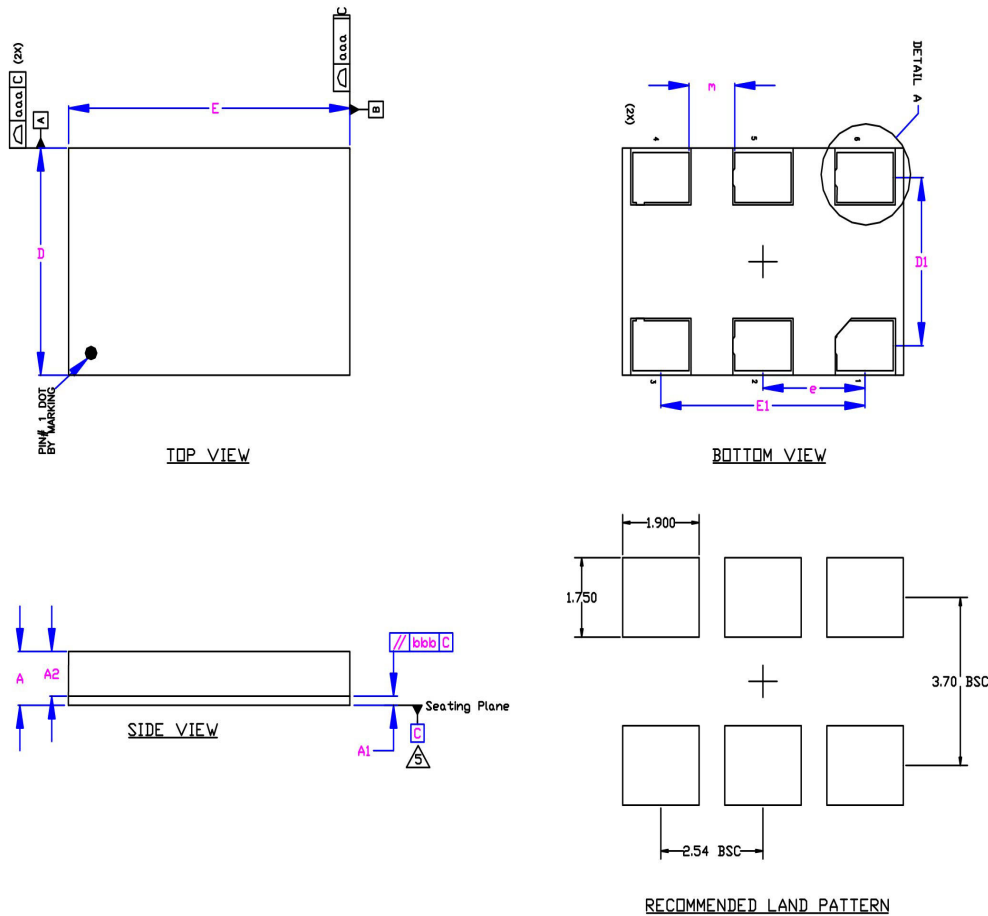
Pin Configuration



Pin Description

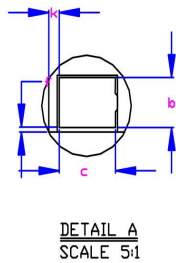
Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVC MOS	Output Enable, disables output to tri-state, 0 = Disabled, 1 = Enabled, 50k Ohms Pull-Up
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	LVDS	Clock Output Frequency = 106.25MHz
6	VDD	PWR		Power Supply

Package Information and Recommended Land Pattern for 6-Pin LGA³



Dimensional Tol.	
aaa	0.100
bbb	0.070

Dimensional Ref.			
REF.	Min.	Nom.	Max.
A	1.260	1.330	1.400
A1	0.190	0.230	0.270
A2	1.070	1.100	1.130
D	4.900	5.000	5.100
D1	3.700 BSC		
E	6.900	7.000	7.100
E1	5.000 BSC		
b	1.050	1.100	1.150
c	1.350	1.400	1.450
e	2.540 BSC		
f	0.050	0.100	0.150
k	0.210	0.260	0.310
m	1.090	1.140	1.190
n	36		



- Notes
1. Dimensioning and Tolerancing per ASME Y14.5M-1994.
 2. Dimensions are in millimeters.
 3. 'e' represents the basic LGA pitch
 4. 'n' is the maximum no. of Land for a specified Package.
 5. Package warp shall be 0.150 max.
 6. Substrate base is BT Resin
 7. The Pin#1 corner must be identified on top side only.
 8. Reference Jeduc Spec M1-221
 9. Land pattern tolerance is 0.05mm unless otherwise specified

6-Pin LGA (7x5mm)

Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

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